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General Information

Series	CQ
Style	SMD Chip
Features	Ultra High Q, Low ESR, Class I
RoHS	Yes
Termination	Tin

Dimensions

L	0.6mm +/-0.03mm
W	0.3mm +/-0.03mm
T	0.3mm +/-0.03mm
B	0.15mm +/-0.050mm
Case Code (EIA / mm)	0201 / 0603

Packaging Specifications

Packaging	T&R, 330mm, Paper Tape
Packaging Quantity	50000

Specifications

Capacitance	9 pF
Tolerance	+/-0.1 pF
Voltage DC	50 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Dissipation Factor	0.17%
Insulation Resistance	10 GOhms

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